

FlexTwin SuperServer AS -2126FT-HE-ALC

2U 4-Node FlexTwin™ with advanced liquid cooling (complete rack and onsite service are required)

Key Applications

 $\label{lem:computing} \mbox{ Gas, Scientific Research, High Performance Computing (HPC), Research Lab.}$

Key Features

- Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:;
- Dual AMD EPYC[™] 9005 Series Processors up to 500W with advanced liquid cooling;
- Supports up to 24 DIMM Slots, 6400 MT/s 6TB DDR5 memory (Please check System Memory Section for detail);
- Optional 1 PCle 5.0 x16 FHHL slot + 1 PCle 5.0 x16 LP slot;
- Flexible networking with up to 1 OCP 3.0 compatible AIOM slots;
- Optional 2 E1.S Slots + Optional 2 M.2 NVME drive Slots;
- Total of 2x (2000W, 2700W or 3200W) Redundant (1 + 1) Titanium Level power supplies

(Power supply full redundancy based on configuration and application load);



Form Factor	2U Rackmount Enclosure: 449 x 88 x 916.6mm (17.67" x 3.46" x 36.08") Package: 701 x 293 x 1286mm (27.6" x 11.54" x 50.63")
Processor	Dual processor(s)
	AMD EPYC™ 9005 Series Processors
	Up to 192C/384T; Up to 512MB Cache per CPU
System Memory	Slot Count: 24 DIMM slots
	Max Memory (1DPC): Up to 6TB 6400MT/s ECC DDR5 RDIMM
Drive Bays Configuration	Option A: Total 2 bays
	2 front hot-swap E1.S NVMe drive bays
	M.2: 2 M.2 PCIe 5.0 x4 NVMe slots (M-key 22110; optional configuration)
Expansion Slots	PCI-Express (PCIe) Configuration: Default
	• 1 PCIe 5.0 x16 LP slot
	 1 PCIe 5.0 x16 AIOM slot (OCP 3.0 compatible)
	Option A*
	• 1 PCle 5.0 x16 (in x16) LP slot
	 1 PCIe 5.0 x16 (in x16) AIOM slot (OCP 3.0 compatible)
	• 1 PCIe 5.0 x16 (in x16) FHHL slot
	M.2: 2 M.2 NVMe slots (M-key 22110(default); optional configuration)
On-Board Devices	Chipset: System on Chip
	Network Connectivity: Via AIOM
	IPMI: Support for Intelligent Platform Management Interface v.2.0
	IPMI 2.0 with virtual media over LAN and KVM-over-LAN support
Input / Output	LAN: 1 RJ45 1 GbE Dedicated BMC LAN port
	USB: 2 USB 2.0 ports(front)
	Video: 1 VGA port
	Serial: 1 COM RS232 port(Front)
	TPM: 1 TPM Onboard/port 80



(Front View - System)

Power Button LED

2 USB 2 0 Ports

Node B

Node A

UD Button LED

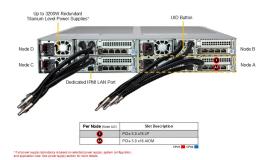
Dive Bay Role A (0)

2 Hot Swap E1 S Wild Dive Bay (optional)

Port Node Note A (0)

Port S out Sirver, (optional)

(Rear View - System



System Cooling Fans: Up to 16 counter-rotating 40x40x56mm Fan(s)

Air Shroud: 4 Air Shrouds

Liquid Cooling: Direct to Chip (D2C) Cold Plate

Power Supply 2x 2000W Redundant (1 + 1) Titanium Level (96%) power supplies

System BIOS BIOS Type: AMI 64MB SPI Flash EEPROM

BIOS Features: Plug and Play (PnP)

UEFI 2.8

USB Keyboard support

ACPI 6.5

SMBIOS 3.7 or later

Management Supermicro Server Manager (SSM); Super Diagnostics Offline (SDO); KVM with dedicated LAN; IPMI 2.0;

Supermicro Thin-Agent Service (TAS); SuperServer Automation Assistant (SAA) New!

PC Health Monitoring CPU: Monitors for CPU Cores, Chipset Voltages, Memory

FAN: Fans with tachometer monitoring
Status monitor for speed control

Pulse Width Modulated (PWM) fan connectors

Temperature: Monitoring for CPU and chassis environment

Voltage:

 $System\ temperature, Memory\ temperature, CPU\ temperature, 3.3V\ standby, +5V\ standby, +5V, +3.3V, +12V, CPU\ temperature, +5V\ standby, +5V, +3.3V, +12V, CPU\ standby, +5V\ standby, +5V, +3.3V, +12V, CPU\ standby, +5V\ standby, +5V, +3.3V, +12V, CPU\ standby, +5V\ standby, +5V\ standby, +5V, +3.3V, +12V, CPU\ standby, +5V\ standby,$

thermal trip support

Dimensions and Weight Weight: Gross Weight: 174.87 lbs (79.32 kg)

Net Weight: 130.18 lbs (59.08 kg)

Available Color: Silver

Operating Environment RoHS Compliant

Operating Temperature: 10°C to 35°C (50°F to 95°F)
Non-operating Temperature: -40°C to 60°C (-40°F to 140°F)
Operating Relative Humidity: 8% to 90% (Non-Condensing)
Non-operating Relative Humidity: 5% to 95% (Non-Condensing)

Motherboard Super H14DST-FL

Chassis CSE-F214EC-000NP